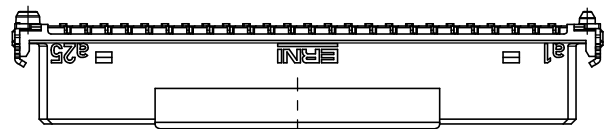
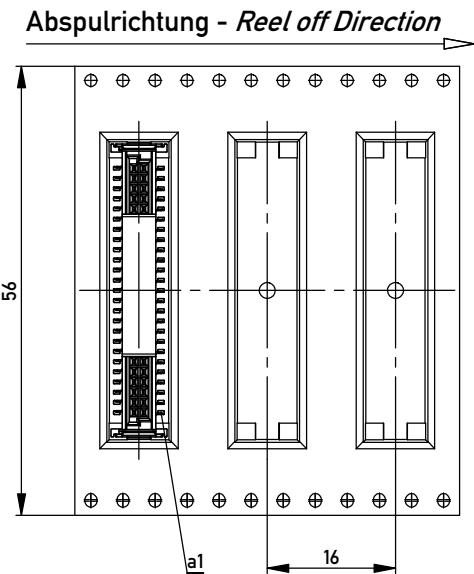
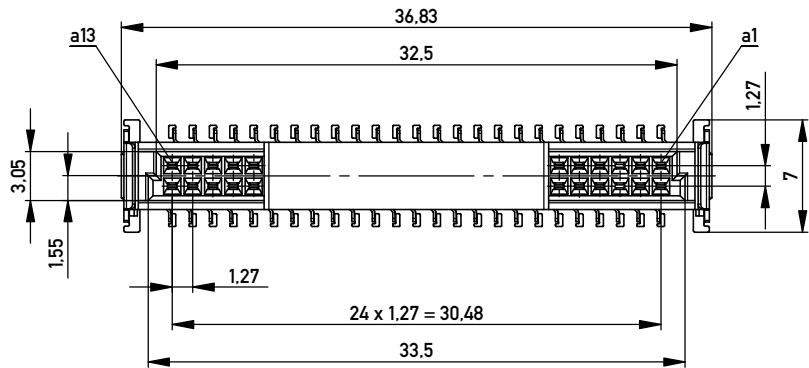
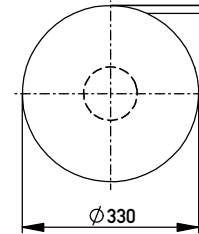


Verpackt im Gurt nach DIN IEC 60286-3  
 Tape on Reel Packaging according to DIN IEC 60286-3  
 Verpackungseinheit: 280 Stück  
 Packaging unit: 280 pcs



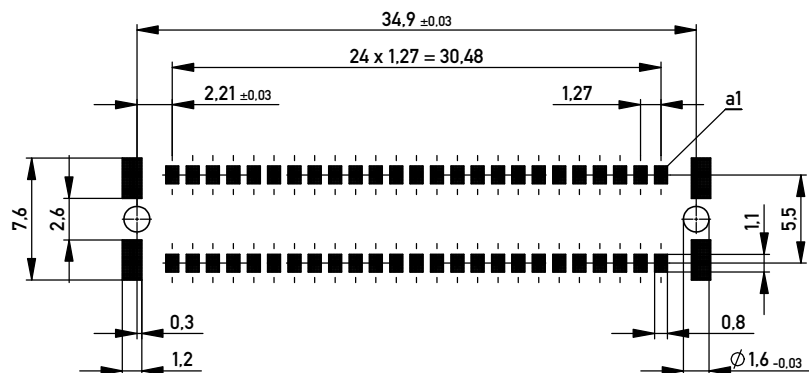
Leiterplatten-Layout Vorschlag für SMT  
 PCB-Layout Proposal for SMT

Anforderungsstufe 1  
 Performance Level 1

Kontaktbereich vergoldet  
 Mating Area gold plating

Anschlussbereich verzinkt 4-6 µm  
 Terminal Area 4-6 µm tin plating

Koplanarität der Anschlüsse ≤ 0,1 mm  
 Coplanarity Area of Termination ≤ 0,1 mm



BA 7-13 - 8mm Bauhöhe  
 type7-13 - Low Profile

Information:	Tolerances	 All Dimensions in mm	Scale	3:1
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Subject to modification without prior notice. Drawing will not be updated.		www.ERNI.com		100100280001
e	14.01.2014	Class		SMCB
Index	Date			K A3

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